

1. General description

Hyperfast power diode in a 2-lead TO220 plastic package



2. Features and benefits

- Low leakage current
- Low thermal resistance
- Low reverse recovery current
- Reduces switching losses in associated MOSFET or IGBT

3. Applications

- Active PFC in air conditioner/EV charger/PV
- Continuous Current Mode (CCM) Power Factor Correction (PFC)
- Half-bridge/full-bridge switched-mode power supplies

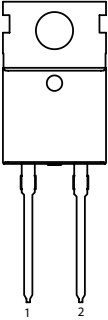
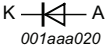
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute maximum rating							
V _{RRM}	repetitive peak reverse voltage			600			V
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 134 °C; Fig. 1 ; Fig. 2 ; Fig. 3		15			A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _{mb} ≤ 134 °C; square-wave pulse		30			A
I _{FSM}	non-repetitive peak forward current	t _p = 10 ms; T _{j(init)} = 25 °C; sine-wave pulse; Fig. 4		200			A
		t _p = 8.3 ms; T _{j(init)} = 25 °C; sine-wave pulse		220			A
Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
Static characteristics							
V _F	forward voltage	I _F = 15 A; T _j = 25 °C; Fig. 6		-	1.92	2.35	V
		I _F = 15 A; T _j = 150 °C; Fig. 6		-	1.27	1.70	V
Dynamic characteristics							
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt = 200 A/μs; T _j = 25 °C; Fig. 7		-	16	-	ns

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		
2	A	anode		
mb	mb	mounting base; connected to cathod		

6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
BYC15M-600P	TO220-2L	BYC15M-600PQ	Tube	50	TO220d-2L	13-Oct-2022

7. Marking

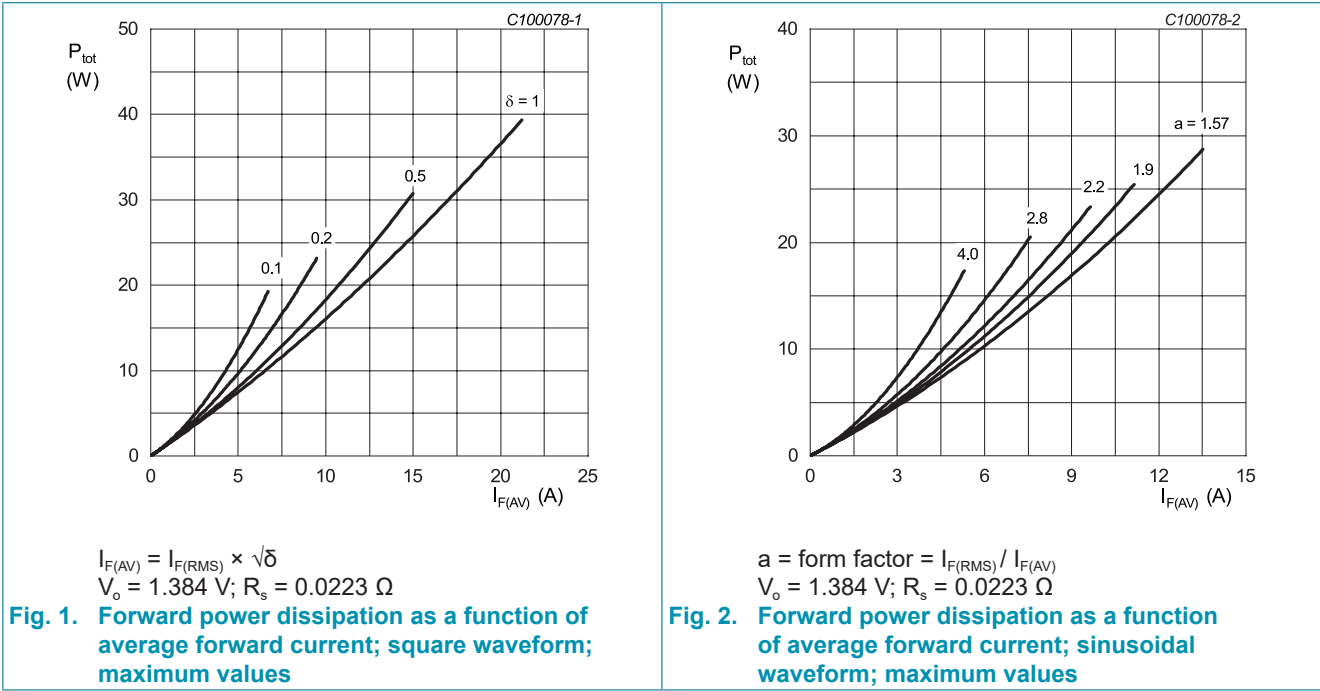
Table 4. Marking codes

Type number	Marking codes
BYC15M-600P	BYC15M 600P

8. Limiting values

Table 5. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V _{RRM}	repetitive peak reverse voltage			600	V
V _{RWM}	crest working reverse voltage			600	V
V _R	reverse voltage	DC		600	V
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 134 °C; Fig. 1 ; Fig. 2 ; Fig. 3		15	A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _{mb} ≤ 134 °C; square-wave pulse		30	A
I _{FSM}	non-repetitive peak forward current	t _p = 10 ms; T _{j(init)} = 25 °C; sine-wave pulse; Fig. 4		200	A
		t _p = 8.3 ms; T _{j(init)} = 25 °C; sine-wave pulse		220	A
T _{stg}	storage temperature			-65 to 175	°C
T _j	junction temperature			-65 to 175	°C



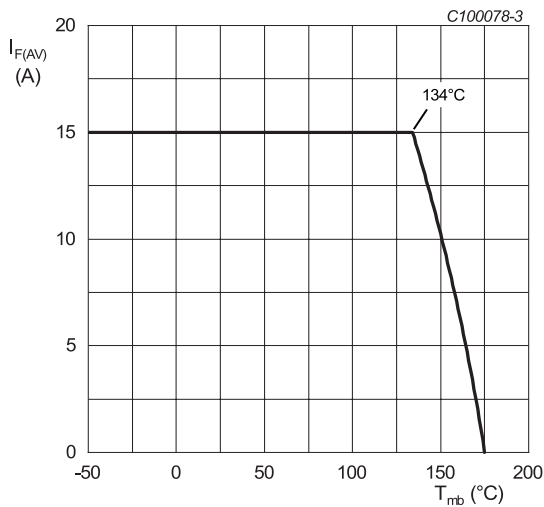


Fig. 3. Forward current as a function of mounting base temperature; maximum values

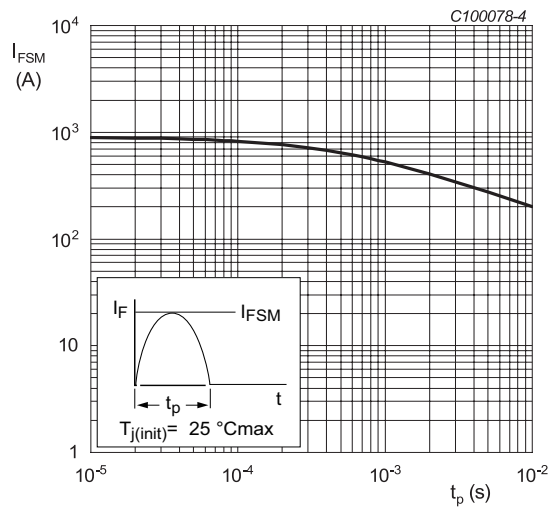


Fig. 4. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	Fig. 5		-	-	1.33	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air		-	60	-	K/W

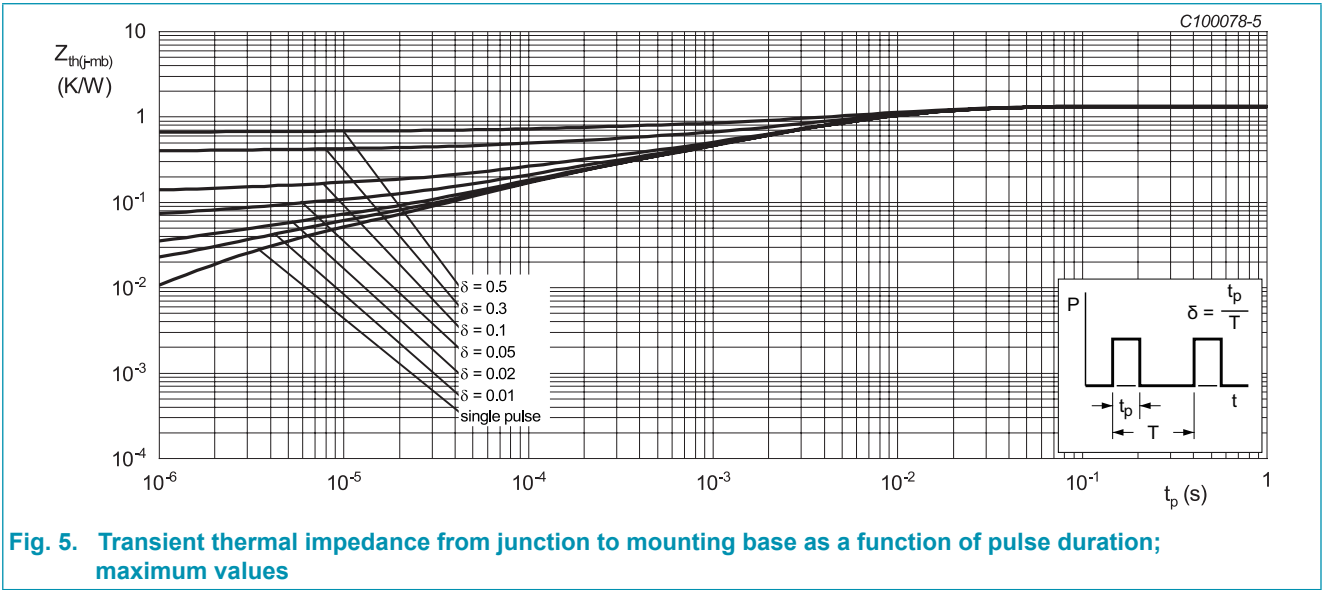
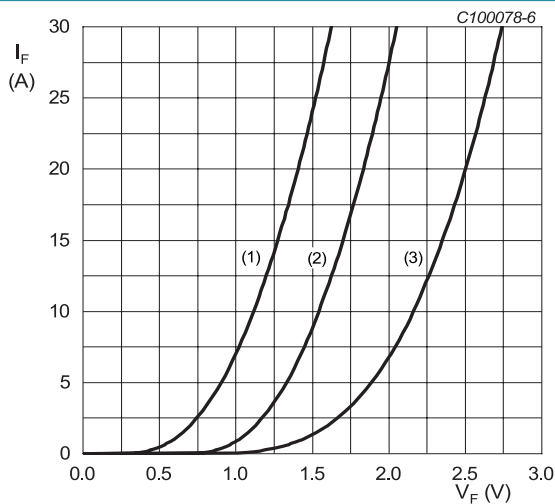


Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration; maximum values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
Static characteristics							
V _F	forward voltage	I _F = 15 A; T _j = 25 °C; Fig. 6		-	1.92	2.35	V
		I _F = 15 A; T _j = 150 °C; Fig. 6		-	1.27	1.70	V
I _R	reverse current	V _R = 600 V; T _j = 25 °C		-	0.71	10	μA
		V _R = 600 V; T _j = 150 °C		-	-	0.5	mA
Dynamic characteristics							
Q _r	reverse charge	I _F = 15 A; V _R = 400 V; dI _F /dt = 500 A/μs; T _j = 25 °C; Fig. 7		-	75	-	nC
		I _F = 15 A; V _R = 400 V; dI _F /dt = 500 A/μs; T _j = 125 °C; Fig. 7		-	204	-	nC
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt = 200 A/μs; T _j = 25 °C; Fig. 7		-	16	-	ns
		I _F = 15 A; V _R = 400 V; dI _F /dt = 500 A/μs; T _j = 25 °C; Fig. 7		-	26	-	ns
		I _F = 15 A; V _R = 400 V; dI _F /dt = 500 A/μs; T _j = 125 °C; Fig. 7		-	38	-	ns
I _{RM}	peak reverse recovery current	I _F = 15 A; V _R = 400 V; dI _F /dt = 500 A/μs; T _j = 25 °C; Fig. 7		-	5.7	-	A
		I _F = 15 A; V _R = 400 V; dI _F /dt = 500 A/μs; T _j = 125 °C; Fig. 7		-	10.8	-	A



$V_o = 1.384\text{ V}$; $R_s = 0.0223\text{ }\Omega$

(1) $T_j = 150\text{ °C}$; typical values

(2) $T_j = 150\text{ °C}$; maximum values

(3) $T_j = 25\text{ °C}$; maximum values

Fig. 6. Forward current as a function of forward voltage

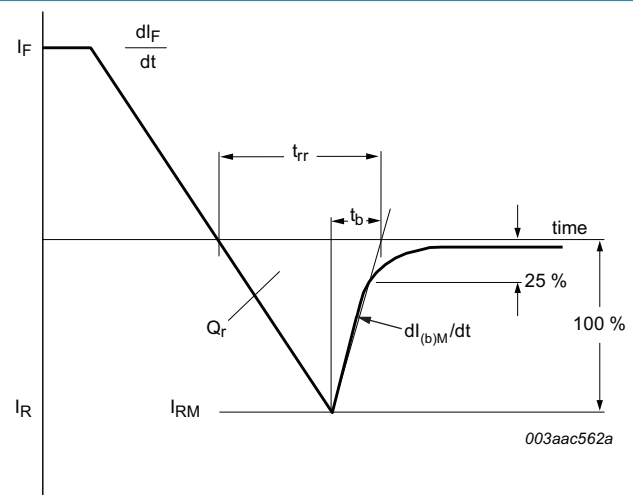


Fig. 7. Reverse recovery definitions; ramp recovery

11. Package outline

Plastic single-ended package; heatsink mounted;1 mounting hole; 2 leads TO-220

TO220-2L

Unit	A	A1	b	b1	c	D	D1	D2	E	E1	e	H	L	P	Q	q	
MM	min	4.30	1.15	0.70	1.20	0.45	15.50	6.20	13.00	9.65	7.80	4.95	15.70	12.60	3.65	2.20	2.70
	max	4.70	1.40	0.95	1.70	0.65	16.20	6.80	13.70	10.30	8.20	5.18	16.25	13.80	3.80	2.60	2.90

Note:
1. All dimensions don't include mold flash and metal protrusion.

12. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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